## **Certification Report**

## BSI-DSZ-CC-0977-V3-2021

for

# NXP Secure Smart Card Controller N7021 VA including IC Dedicated Software

from

**NXP Semiconductors Germany GmbH** 

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Certification Report V1.0 CC-Zert-327 V5.4





#### BSI-DSZ-CC-0977-V3-2021 (\*)

**Smartcard Controller** 

## NXP Secure Smart Card Controller N7021 VA including IC Dedicated Software

from NXP Semiconductors Germany GmbH

PP Conformance: Security IC Platform Protection Profile with

Augmentation Packages Version 1.0, 13 January

2014, BSI-CC-PP-0084-2014

Functionality: PP conformant plus product specific extensions

Common Criteria Part 2 extended

Assurance: Common Criteria Part 3 conformant

EAL 6 augmented by ASE TSS.2 and ALC FLR.1

SOGIS
IT SECURITY CERTIFIED

SOGIS Recognition Agreement



The IT Product identified in this certificate has been evaluated at an approved evaluation facility using the Common Methodology for IT Security Evaluation (CEM), Version 3.1 extended by Scheme Interpretations by advice of the Certification Body for components beyond EAL 5 and CC Supporting Documents as listed in the Certification Report for conformance to the Common Criteria for IT Security Evaluation (CC), Version 3.1. CC and CEM are also published as ISO/IEC 15408 and ISO/IEC 18045.

(\*) This certificate applies only to the specific version and release of the product in its evaluated configuration and in conjunction with the complete Certification Report and Notification. For details on the validity see Certification Report part A chapter 5.

The evaluation has been conducted in accordance with the provisions of the certification scheme of the German Federal Office for Information Security (BSI) and the conclusions of the evaluation facility in the evaluation technical report are consistent with the evidence adduced.

This certificate is not an endorsement of the IT Product by the Federal Office for Information Security or any other organisation that recognises or gives effect to this certificate, and no warranty of the IT Product by the Federal Office for Information Security or any other organisation that recognises or gives effect to this certificate, is either expressed or implied.

Bonn, 24 February 2021

For the Federal Office for Information Security



Common Criteria Recognition Arrangement recognition for components up to EAL 2 and ALC\_FLR only



Sandro Amendola Head of Division L.S.

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#### A. Certification

## 1. Preliminary Remarks

Under the BSIG¹ Act, the Federal Office for Information Security (BSI) has the task of issuing certificates for information technology products.

Certification of a product is carried out on the instigation of the vendor or a distributor, hereinafter called the sponsor.

A part of the procedure is the technical examination (evaluation) of the product according to the security criteria published by the BSI or generally recognised security criteria.

The evaluation is normally carried out by an evaluation facility recognised by the BSI or by BSI itself.

The result of the certification procedure is the present Certification Report. This report contains among others the certificate (summarised assessment) and the detailed Certification Results.

The Certification Results contain the technical description of the security functionality of the certified product, the details of the evaluation (strength and weaknesses) and instructions for the user.

## 2. Specifications of the Certification Procedure

The certification body conducts the procedure according to the criteria laid down in the following:

- Act on the Federal Office for Information Security<sup>1</sup>
- BSI Certification and Approval Ordinance<sup>2</sup>
- BMI Regulations on Ex-parte Costs<sup>3</sup>
- Special decrees issued by the Bundesministerium des Innern (Federal Ministry of the Interior)
- DIN EN ISO/IEC 17065 standard
- BSI certification: Scheme documentation describing the certification process (CC-Produkte) [3]
- BSI certification: Scheme documentation on requirements for the Evaluation Facility, its approval and licencing process (CC-Stellen) [3]

Act on the Federal Office for Information Security (BSI-Gesetz - BSIG) of 14 August 2009, Bundesgesetzblatt I p. 2821

Ordinance on the Procedure for Issuance of Security Certificates and approval by the Federal Office for Information Security (BSI-Zertifizierungs- und -Anerkennungsverordnung - BSIZertV) of 17 December 2014, Bundesgesetzblatt 2014, part I, no. 61, p. 2231

BMI Regulations on Ex-parte Costs - Besondere Gebührenverordnung des BMI für individuell zurechenbare öffentliche Leistungen in dessen Zuständigkeitsbereich (BMIBGebV), Abschnitt 7 (BSI-Gesetz) - dated 2 September 2019, Bundesgesetzblatt I p. 1365

- Common Criteria for IT Security Evaluation (CC), Version 3.1<sup>4</sup>[1] also published as ISO/IEC 15408.
- Common Methodology for IT Security Evaluation (CEM), Version 3.1 [2] also published as ISO/IEC 18045
- BSI certification: Application Notes and Interpretation of the Scheme (AIS) [4]

## 3. Recognition Agreements

In order to avoid multiple certification of the same product in different countries a mutual recognition of IT security certificates - as far as such certificates are based on ITSEC or CC - under certain conditions was agreed.

#### 3.1. European Recognition of CC – Certificates (SOGIS-MRA)

The SOGIS-Mutual Recognition Agreement (SOGIS-MRA) Version 3 became effective in April 2010. It defines the recognition of certificates for IT-Products at a basic recognition level and, in addition, at higher recognition levels for IT-Products related to certain SOGIS Technical Domains only.

The basic recognition level includes Common Criteria (CC) Evaluation Assurance Levels EAL 1 to EAL 4. For "Smartcards and similar devices" a SOGIS Technical Domain is in place. For "HW Devices with Security Boxes" a SOGIS Technical Domains is in place, too. In addition, certificates issued for Protection Profiles based on Common Criteria are part of the recognition agreement.

The current list of signatory nations and approved certification schemes, details on recognition, and the history of the agreement can be seen on the website at <a href="https://www.sogis.eu">https://www.sogis.eu</a>.

The SOGIS-MRA logo printed on the certificate indicates that it is recognised under the terms of this agreement by the related bodies of the signatory nations. A disclaimer beneath the logo indicates the specific scope of recognition.

This certificate is recognized under SOGIS-MRA for all assurance components selected.

#### 3.2. International Recognition of CC – Certificates (CCRA)

The international arrangement on the mutual recognition of certificates based on the CC (Common Criteria Recognition Arrangement, CCRA-2014) has been ratified on 08 September 2014. It covers CC certificates based on collaborative Protection Profiles (cPP) (exact use), CC certificates based on assurance components up to and including EAL 2 or the assurance family Flaw Remediation (ALC\_FLR) and CC certificates for Protection Profiles and for collaborative Protection Profiles (cPP).

The current list of signatory nations and approved certification schemes can be seen on the website: <a href="https://www.commoncriteriaportal.org">https://www.commoncriteriaportal.org</a>.

The Common Criteria Recognition Arrangement logo printed on the certificate indicates that this certification is recognised under the terms of this agreement by the related bodies of the signatory nations. A disclaimer beneath the logo indicates the specific scope of recognition.

Proclamation of the Bundesministerium des Innern of 12 February 2007 in the Bundesanzeiger dated 23 February 2007, p. 3730

This certificate is recognized according to the rules of CCRA-2014, i. e. up to and including CC part 3 EAL 2+ ALC\_FLR components.

#### 4. Performance of Evaluation and Certification

The certification body monitors each individual evaluation to ensure a uniform procedure, a uniform interpretation of the criteria and uniform ratings.

The product NXP Secure Smart Card Controller N7021 VA including IC Dedicated Software has undergone the certification procedure at BSI. This is a re-certification based on BSI-DSZ-CC-0977-V2-2019. Specific results from the evaluation process BSI-DSZ-CC-0977-V2-2019 were re-used.

The evaluation of the product NXP Secure Smart Card Controller N7021 VA including IC Dedicated Software was conducted by TÜV Informationstechnik GmbH. The evaluation was completed on 10 February 2021. TÜV Informationstechnik GmbH is an evaluation facility (ITSEF)<sup>5</sup> recognised by the certification body of BSI.

For this certification procedure the sponsor and applicant is: NXP Semiconductors Germany GmbH.

The product was developed by: NXP Semiconductors Germany GmbH.

The certification is concluded with the comparability check and the production of this Certification Report. This work was completed by the BSI.

## 5. Validity of the Certification Result

This Certification Report applies only to the version of the product as indicated. The confirmed assurance package is valid on the condition that

- all stipulations regarding generation, configuration and operation, as given in the following report, are observed,
- the product is operated in the environment described, as specified in the following report and in the Security Target.

For the meaning of the assurance components and assurance levels please refer to CC itself. Detailed references are listed in part C of this report.

The Certificate issued confirms the assurance of the product claimed in the Security Target at the date of certification. As attack methods evolve over time, the resistance of the certified version of the product against new attack methods needs to be re-assessed. Therefore, the sponsor should apply for the certified product being monitored within the assurance continuity program of the BSI Certification Scheme (e.g. by a re-assessment or re-certification). Specifically, if results of the certification are used in subsequent evaluation and certification procedures, in a system integration process or if a user's risk management needs regularly updated results, it is recommended to perform a re-assessment on a regular e.g. annual basis.

In order to avoid an indefinite usage of the certificate when evolved attack methods would require a re-assessment of the products resistance to state of the art attack methods, the maximum validity of the certificate has been limited. The certificate issued on 24 February 2021 is valid until 23 February 2026. Validity can be renewed by re-certification.

<sup>&</sup>lt;sup>5</sup> Information Technology Security Evaluation Facility

The owner of the certificate is obliged:

 when advertising the certificate or the fact of the product's certification, to refer to the Certification Report as well as to provide the Certification Report, the Security Target and user guidance documentation mentioned herein to any customer of the product for the application and usage of the certified product,

- 2. to inform the Certification Body at BSI immediately about vulnerabilities of the product that have been identified by the developer or any third party after issuance of the certificate.
- 3. to inform the Certification Body at BSI immediately in the case that security relevant changes in the evaluated life cycle, e.g. related to development and production sites or processes, occur, or the confidentiality of documentation and information related to the Target of Evaluation (TOE) or resulting from the evaluation and certification procedure where the certification of the product has assumed this confidentiality being maintained, is not given any longer. In particular, prior to the dissemination of confidential documentation and information related to the TOE or resulting from the evaluation and certification procedure that do not belong to the deliverables according to the Certification Report part B, or for those where no dissemination rules have been agreed on, to third parties, the Certification Body at BSI has to be informed.

In case of changes to the certified version of the product, the validity can be extended to the new versions and releases, provided the sponsor applies for assurance continuity (i.e. re-certification or maintenance) of the modified product, in accordance with the procedural requirements, and the evaluation does not reveal any security deficiencies.

#### 6. Publication

The product NXP Secure Smart Card Controller N7021 VA including IC Dedicated Software has been included in the BSI list of certified products, which is published regularly (see also Internet: <a href="https://www.bsi.bund.de">https://www.bsi.bund.de</a> and [5]). Further information can be obtained from BSI-Infoline +49 228 9582-111.

Further copies of this Certification Report can be requested from the developer<sup>6</sup> of the product. The Certification Report may also be obtained in electronic form at the internet address stated above.

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## B. Certification Results

The following results represent a summary of

- the Security Target of the sponsor for the Target of Evaluation,
- the relevant evaluation results from the evaluation facility, and
- complementary notes and stipulations of the certification body.

## 1. Executive Summary

The Target of Evaluation (TOE) is the IC hardware platform "NXP Secure Smart Card Controller N7021 VA with IC Dedicated Software" and documentation describing instruction set and usage of the TOE. The TOE does not include a customer-specific Security IC Embedded Software.

The IC Dedicated Software comprises IC Dedicated Test Software for test purposes and IC Dedicated Support Software. The IC Dedicated Support Software consists of the Boot Software, which controls the boot process of the hardware platform. Furthermore, it provides a Firmware Interface and optionally a Library Interface, simplifying access to the hardware for the Security IC Embedded Software. A System Mode OS is available (optional), offering ready-to-use resource and access management for customer applications that do not want to be exposed to the more low-level features of the TOE. The Flashloader OS (optional) supports download of code and data to Flash by the Composite Product Manufacturer before Operational Usage (e.g. during development). The Symmetric Crypto Library (optional) provides simplified access to frequently used symmetric cryptography algorithms.

The Security Target [6] is the basis for this certification. It is based on the certified Protection Profile "Security IC Platform Protection Profile with Augmentation Packages Version 1.0, 13 January 2014, BSI-CC-PP-0084-2014" [8].

The TOE Security Assurance Requirements (SAR) are based entirely on the assurance components defined in Part 3 of the Common Criteria (see part C or [1], Part 3 for details). The TOE meets the assurance requirements of the Evaluation Assurance Level EAL 6 augmented by ASE\_TSS.2 and ALC\_FLR.1.

The TOE Security Functional Requirements (SFR) relevant for the TOE are outlined in the Security Target [6] and [9], chapter 6.1. They are selected from Common Criteria Part 2 and some of them are newly defined. Thus the TOE is CC Part 2 extended.

The TOE Security Functional Requirements are implemented by the following TOE Security Functionality:

TOE Security Functionality	Addressed issue
Security Services	
SS.RNG	Random Number Generator
SS.SW_RNG	Hybrid Deterministic/Hybrid Physical Random Number Generator
SS.HW_TDES	Triple-DES coprocessor
SS.SW_DES	Triple-DES Software Support
SS.HW_AES	AES coprocessor
SS.SW_AES	AES Software Support
SS.Loader	Loader
SS.SELF_TEST	Self Test
SS.RESET	Reset Functionality
SS. RECONFIG	Post Delivery Configuration
Security Features	
SF.OPC	Control of Operating Conditions

TOE Security Functionality	Addressed issue	
SF.PHY	Protection against Physical Manipulation	
SF.LOG	Logical Protection	
SF.COMP	Protection of Mode Control	
SF.MEM_ACC	Memory Access Control	
SF.SFR_ACC	Special Function Register Acess Control	
SF.Object_Reuse	Reuse of Memory	
SF.PUF	PUF	

Table 1: TOE Security Functionalities

For more details please refer to the Security Target [6] and [9], chapter 6.1.

The assets to be protected by the TOE are defined in the Security Target [6] and [9], chapter 6.2. Based on these assets the TOE Security Problem is defined in terms of Assumptions, Threats and Organisational Security Policies. This is outlined in the Security Target [6] and [9], chapter 3.

This certification covers the configurations of the TOE as outlined in chapter 8.

The vulnerability assessment results as stated within this certificate do not include a rating for those cryptographic algorithms and their implementation suitable for encryption and decryption (see BSIG Section 9, Para. 4, Clause 2).

The certification results only apply to the version of the product indicated in the certificate and on the condition that all the stipulations are kept as detailed in this Certification Report. This certificate is not an endorsement of the IT product by the Federal Office for Information Security (BSI) or any other organisation that recognises or gives effect to this certificate, and no warranty of the IT product by BSI or any other organisation that recognises or gives effect to this certificate, is either expressed or implied.

#### 2. Identification of the TOE

The Target of Evaluation (TOE) is called:

#### NXP Secure Smart Card Controller N7021 VA including IC Dedicated Software

The following table outlines the TOE deliverables:

No	Туре	Identifier	Release	Form of Delivery
Deliv	erables for all confi	igurations of the TOE		
1	IC Hardware	N7021 VA	VA	Wafer, modules and package
2	IC Dedicated Test Software	Test software	20.0	On-chip software
3	IC Dedicated Support Software	Boot software	20.0	On-chip software
4	IC Dedicated Support Software	Firmware interface	20.0	On-chip software

No	Туре	Identifier	Release	Form of Delivery	
5	Document	SmartMX3 family P71D320 Overview, pinning and electrical characteristics Product data sheet [11]	3.1 / 2019-06-04	PDF via NXP DocStore	
6	Document	SmartMX3 N7021 Instruction Set Manual Objective data sheet addendum [12]	1.4 / 2016-09-29	PDF via NXP DocStore	
7	Document	SmartMX3 family N7021 Wafer and delivery specification Objective wafer specification [13]	1.3 / 2018-05-15	PDF via NXP DocStore	
8	Document	SmartMX3 N7021 Post Delivery Configuration Post Delivery Configuration Objective data sheet addendum [14]	1.1 / 2017-03-22	PDF via NXP DocStore	
9	Document	SmartMX3 N7021 Chip Health Mode Chip Health Mode Objective data sheet addendum [15]	1.0 / 2016-12-06	PDF via NXP DocStore	
10	Document	SmartMX3 N7021 Peripheral Configuration and Use, Peripheral Configuration and Use on the N7021, Objective data sheet addendum [16]	1.5 / 2019-12-12	PDF via NXP DocStore	
11	Document	SmartMX3 N7021 MMU configuration & FW interface, Access / resource management and security configuration, Data Sheet addendum [17]	1.5 / 2017-11-03	PDF via NXP DocStore	
12	Document	SmartMX3 N7021 N7021 – Inter- Card Communication, Inter-Card Communication Functionality and additional APIs on the N7021, Objective data sheet addendum [18]	1.1 / 2017-03-09	PDF via NXP DocStore	
13	Document	SmartMX3 N7021 N7021 – NVM Operate Function NVM Operate Function, Use on the N7021, Objective data sheet addendum [19]	1.0 / 2017-01-13	PDF via NXP DocStore	
14	Document	NXP Secure Smart Card Controller N7021, Information on Guidance and Operation, Guidance and Operation Manual [20]	1.4 / 2019-06-04	PDF via NXP DocStore	
Deliv	Deliverables of the Flashloader OS				
15	IC Dedicated Support Software	Flashloader OS	20.0	On-chip software	
16	Document	SmartMX3 N7021 FlashLoader, FlashLoader for N7021: Protocol and Application Objective data sheet addendum [21]	1.3 / 2018-08-24	PDF via NXP DocStore	

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No	Туре	Identifier	Release	Form of Delivery		
Deliv	Deliverables of the Library Interface					
17	IC Dedicated Support Software	Library Interface	20.0	On-chip software		
18	Library File	libComm	20.0	SDK installer via NXP DocStore		
19	Library File	libCrc	20.0	SDK installer via NXP DocStore		
20	Library File	libMem	20.0	SDK installer via NXP DocStore		
21	Library File	libFL	20.0	SDK installer via NXP DocStore		
22	Document	SmartMX3 N7021 Shared OS Libraries Memory, communication and CRC, including guidance and operation, Objective data sheet addendum [22]	1.2 / 2017-11-03	PDF via NXP DocStore		
Deliv	verables of the Syst	tem Mode OS				
23	IC Dedicated Support Software	System Mode OS	20.0	On-chip software		
24	Document	SmartMX3 N7021 NXP System Mode OS Interface, UM configuration and applications, Objective data sheet addendum [23]	1.6 / 2017-11-03	PDF via NXP DocStore		
Deliv	verables of the Cryp	oto Library Iron				
25	IC Dedicated Support Software	Crypto Library Iron	2.0.6-01	On-chip software		
26	Library Files	Crypto Library Iron	2.0.6-01	SDK installer via NXP DocStore		
27	Document	Crypto Library V1.0 on N7021 VA, Symmetric Cipher Library (SymCfg), User manual [24]	1.2 / 2017-02-13	PDF via NXP DocStore		
28	Document	N7021 Crypto Library RNG Library, Product user manual [25]	1.3 / 2017-03-27	PDF via NXP DocStore		
29	Document	N7021 Crypto Library, Utils Library, User manual [26]	1.1 / 2016-11-28	PDF via NXP DocStore		
30	Document	Crypto Library Iron on N7021 VA, Information on Guidance and Operation, User manual [27]	2.1 / 2020-09-24	PDF via NXP DocStore		

Table 2: Deliverables of the TOE

The requirements for the delivery of the TOE are described in chapter 31 of the "Product Data Sheet" [11]. For each delivery form of the hardware platform NXP offers two ways of delivery of the TOE:

- 1. The customer collects the product himself at the NXP site (see table 4).
- 2. The product is sent to the customer by NXP with special protective measures.

The TOE documentation and related software (items are marked in Table 2) are delivered in electronic form by the document control centre of NXP.

The hardware version can be identified by a coded nameplate as described in [13] chapters 2.9.2 and 3.2.

The TOE further provides the FabKey which can be configured by the customer to hold 128 bytes for batch, wafer or die individual data and can be read out by the configuration interface (see GetFabKey API in [17], chapter 5 and [23], chapter 5.2). The process of FabKey submission is described in [11], chapter 26.

Only the configurations defined in [17], chapter 5.6.3.2, Tab. 5.40 and in [23], chapter 5.8.3.2, Tab. 5.57 are evaluated options.

The ST references the version of the Crypto Library. This version number is also noted in the [27], chapter 2 thus the TOE components listed in the guidance are traceable to the reference given in the Security Target [6] and [9]. Furthermore, [27], chapter 2 describes the integrity and confidentiality check of files associated with the crypto library. It lists SHA-256 values for each library file for identification purposes. In addition to identifying the delivered components, the library identifies itself via its "GetVersion" command.

## 3. Security Policy

The security policy enforced is defined by the selected set of Security Functional Requirements and implemented by the TOE. It covers the following issues:

The Security Policy of the TOE is to provide basic security functionalities to be used by the smart card operating system and the smart card application thus providing an overall smart card system security. Therefore, the TOE will implement the symmetric cryptographic block cipher algorithm to ensure the confidentiality of plain text data by encryption and to support secure authentication protocols and it will provide a True Random Number Generator (TRNG) and Deterministic Random Number Generator (DRNG).

As the TOE is a hardware security platform, the security policy of the TOE is also to provide protection against leakage of information (e.g. to ensure the confidentiality of cryptographic keys during cryptographic functions performed by the TOE), against physical probing, against malfunctions, against physical manipulations and against abuse of functionality. Hence, the TOE shall

- maintain the integrity and the confidentiality of data stored in the memory of the TOE, and
- maintain the integrity, the correct operation and the confidentiality of security functionalities (security mechanisms and associated functions) provided by the TOF

Specific details concerning the above mentioned security policies can be found in Chapter 7 of the Security Target [6].

## 4. Assumptions and Clarification of Scope

The Assumptions defined in the Security Target and some aspects of Threats and Organisational Security Policies are not covered by the TOE itself. These aspects lead to specific security objectives to be fulfilled by the TOE-Environment. The following topics are of relevance: OE.Resp-Appl, OE.Process-Sec-IC, OE.Lim\_Block\_Loader, OE.Loader\_Usage, OE.Check-Init. Details can be found in the Security Target [6] and [9], chapter 4.2 and 4.3.

#### 5. Architectural Information

The IC hardware is a microcontroller incorporating a central processing unit (CPU), memories accessible via a Memory Management Unit (MMU), cryptographic coprocessors, other security components and several electrical communication interfaces. The central processing unit supports a 32-/16-bit instruction set optimized for smart card applications. The first and in some cases the second byte of an instruction are used for operation encoding. On-chip memories are ROM, RAM and Flash. The Flash can be used as data or program memory. It consists of highly reliable memory cells, which are designed to provide data integrity. Flash is optimized for applications that require reliable non-volatile data storage for data and program code. Dedicated security functionality protects the contents of all memories.

The IC Dedicated Software comprises IC Dedicated Test Software for test purposes and IC Dedicated Support Software. The IC Dedicated Support Software consists of the Boot Software, which controls the boot process of the hardware platform. Furthermore, it provides a Firmware Interface and optionally a Library Interface, simplifying access to the hardware for the Security IC Embedded Software. A System Mode OS is available (optional), offering ready-to-use resource and access management for customer applications that do not want to be exposed to the more low-level features of the TOE. The Flashloader OS (optional) supports download of code and data to Flash by the Composite Product Manufacturer before Operational Usage (e.g. during development). The Symmetric Crypto Library (optional) provides simplified access to frequently used symmetric cryptography algorithms. More Information can be found in chapter 1.3.1 of [6] and [9].

#### 6. Documentation

The evaluated documentation as outlined in table 2 is being provided with the product to the customer. This documentation contains the required information for secure usage of the TOE in accordance with the Security Target.

Additional obligations and notes for secure usage of the TOE as outlined in chapter 10 of this report have to be followed.

## 7. IT Product Testing

Developer's testing approach:

- All TSF and related security mechanisms, subsystems and modules are tested in order to assure complete coverage of all SFR.
- Different classes of tests are performed to test the TOE in a sufficient manner

 Functional Module Verification: For the functional verification, black-box testing and white-box testing is performed to ensure the correct functionality as specified in the functional specification and customer specifications (ordering options).

- Security Verification: This test category addresses the security mechanisms described in the Security Architecture description. Two main categories of security module verification are defined, i.e., integrity protection module verification (fault injection) and DPA module verification (side-channel analysis). This also includes black-box and white-box testing.
- Characterization: This mostly addresses production tests to measure varying parameters in post-silicon verification while all parameters are within the specified limits. The developer performs a Matrix Characterization Run to measure parameters using varying processes (corner material) and different temperatures.
- Qualification: This test category ensures that a developed IC is production ready and has the expected quality. This addresses
  - Electrostatic discharge due to electrostatic stress in the field (contactless communication),
  - Fast aging of the device due to high temperatures to guarantee the life time of the product,
  - Flash qualification to ensure that features like anti-tearing and wear levelling work as specified,
  - Package qualification to ensure that the IC can be placed in the final delivery form (package) under industrial environments and the final product quality is achieved, and
  - PUF qualification to ensure that the promised PUF properties hold in field conditions.
- Validation: Execution of all customer-visible use cases to ensure that the entire system works as defined for customer-visible operation. This includes:
  - on-chip test framework developed to use each officially released product variant and execute each public available API,
  - a Java Card OS is used to execute reference transactions for banking and e-government, and
  - MIFARE tests.

#### Elevator's testing approach:

- The evaluator's objective regarding this aspect was to test the functionality of the TOE as described in the ST and to verify the developer's test results by repeating developer's tests and additionally add independent tests.
- In the course of the evaluation of the TOE the following classes of tests were carried out:
  - Module tests,
  - Simulation tests.
  - Tests in User Mode of logical card B,

- Tests in System Mode of card A and B,
- Tests in Test Mode,
- Hardware tests, and
- Cryptographic library tests.
- With this kind of tests the entire security functionality of the TOE was tested.

## 8. Evaluated Configuration

The N7021 VA can be delivered with various configuration options as described in chapter 1.4.2 of [6] and [9]. The configuration options are divided into two groups: major configuration options and minor configuration options.

Three major configurations can be chosen by the customer during the ordering process:

- Configuration based on 320 kBytes of Flash memory as code space,
- Configuration based on 240 kBytes of Flash memory as code space,
- Configuration based on 144 kBytes of ROM memory as code space.

Each major configuration is provided with several minor configuration options. These minor configuration options (and all others) for NXP Secure Smart Card Controller N7021 VA can be selected by the customer via Order Entry Form (see [28]). The Order Entry Form identifies all the minor configuration options, which are supported by the major configuration.

The N7021 VA hardware platform was tested including all minor configuration options that can be selected based on Table 1.2 in chapter 1.4.2.2 of [6] and [9]. All minor configurations were available to the evaluator. The major configuration does not have dependencies to security features. All minor configuration options that are part of the evaluation were tested. The minor configuration options behave as specified and described in [11] and [20]. Therefore the results described in this document are applicable for all minor configurations described in [6] and [9].

The TOE does not include a customer-specific Security IC Embedded Software.

#### 9. Results of the Evaluation

#### 9.1. CC specific results

The Evaluation Technical Report (ETR) [7] was provided by the ITSEF according to the Common Criteria [1], the Methodology [2], the requirements of the Scheme [3] and all interpretations and guidelines of the Scheme (AIS) [4] as relevant for the TOE.

The Evaluation Methodology CEM [2] was used for those components up to EAL 5 extended by advice of the Certification Body for components beyond EAL 5 and guidance specific for the technology of the product [4] (AIS 34).

The following guidance specific for the technology was used:

- (i) The Application of CC to Integrated Circuits
- (ii) Application of Attack Potential to Smartcards
- (iii) Guidance, Smartcard Evaluation

(see [4], AIS 25, AIS 37).

For RNG assessment the scheme interpretations AIS 31 was used (see [4]).

To support composite evaluations according to AIS 36 the document ETR for composite evaluation [10] was provided and approved. This document provides details of this platform evaluation that have to be considered in the course of a composite evaluation on top.

As a result of the evaluation the verdict PASS is confirmed for the following assurance components:

- All components of the EAL 6 package including the class ASE as defined in the CC (see also part C of this report)
- The components ASE TSS.2 and ALC FLR.1 augmented for this TOE evaluation.

As the evaluation work performed for this certification procedure was carried out as a reevaluation based on the certificate BSI-DSZ-CC-0977-V2-2019, re-use of specific evaluation tasks was possible. The focus of this re-evaluation was on the life cycle and updates in the documentation of the TOE.

The evaluation has confirmed:

• PP Conformance: Security IC Platform Protection Profile with Augmentation

Packages Version 1.0, 13 January 2014, BSI-CC-PP-0084-2014

[8]

• for the Functionality: PP conformant plus product specific extensions

Common Criteria Part 2 extended

• for the Assurance: Common Criteria Part 3 conformant

EAL 6 augmented by ASE TSS.2 and ALC FLR.1

For specific evaluation results regarding the development and production environment see annex B in part D of this report.

The results of the evaluation are only applicable to the TOE as defined in chapter 2 and the configuration as outlined in chapter 8 above.

## 9.2. Results of cryptographic assessment

The strength of the cryptographic algorithms was not rated in the course of this certification procedure (see BSIG Section 9, Para. 4, Clause 2). But cryptographic functionalities with a security level of lower than 100 bits can no longer be regarded as secure without considering the application context. Therefore, for these functionalities it shall be checked whether the related crypto operations are appropriate for the intended system. Some further hints and guidelines can be derived from the 'Technische Richtlinie BSI TR-02102' (https://www.bsi.bund.de).

The following table gives an overview of the cryptographic functionalities inside the TOE to enforce the security policy and outlines its rating from cryptographic point of view. Any Cryptographic Functionality that is marked in column 'Security Level above 100 Bits' of the following table with 'no' achieves a security level of lower than 100 Bits (in general context) only.

No.	Purpose	Cryptographic Mechanism	Standard of Implementation	Key Size in Bits	Security Level above 100 Bits
Hard	Hardware				
1	Cryptographic	3-key Triple DES	[NIST SP800-67]	k  = 168	Yes
	primitive	AES	[FIPS197]	k  = 128 / 192 / 256	Yes
2	Confidentiality	3-key Triple DES in ECB mode without padding	[FIPS197] [NIST SP800-38A]	k  = 128 / 192 / 256	No
		AES in ECB mode without padding	[ADV_ATE, 6.8.3.7.1]	k  = 128	No
3	Key derivation	Proprietary PUF key derivation	[ADV_ATE, 6.8.3.7.1]	k  = 128	Yes
4	Integrity	AES in CBC-MAC mode for MAC generation and verification based on PUF	[FIPS197] [ISO/IEC 9797-1] [ADV_ATE, 6.8.3.7.1]	k  = 128	No
5	Confidentiality	AES in CBC mode based on PUF	[FIPS197] [NIST SP800-38A] [ADV_ATE, 6.8.3.7.1]	k  = 128	Yes
6	Random number generation	Physical RNG PTG.2	[AIS31]	N/A	N/A
Cryp	to Library (option	nal)			
7	Cryptographic	3-key Triple DES	[NIST SP800-67]	k  = 168	Yes
	primitives	AES	[FIPS197]	k  = 128 / 192 / 256	Yes
8	Confidentiality	3-key Triple DES in CBC mode	[NIST SP800-67] [NIST SP800-38A]	k  = 168	Yes
		AES in CBC mode	[FIPS197] [NIST SP800-38A]	k  = 128 / 192 / 256	Yes
9	Authenticity	3-key Triple DES in CBC-MAC mode	[NIST SP 800-67] [ISO_9797-1]	k  = 168	No
		3-key Triple DES in Retail-MAC mode	[NIST SP 800-67] [ISO_9797-1]	k  = 168	Yes

No.	Purpose	Cryptographic Mechanism	Standard of Implementation	Key Size in Bits	Security Level above 100 Bits
		3-key Triple DES in CMAC mode	[NIST SP 800-67] [NIST SP800-38B]	k  = 168	Yes
		AES in CBC-MAC mode	[FIPS197] [ISO_9797-1]	k  = 128 / 192 / 256	No
		AES in CMAC mode	[FIPS197] [NIST SP800-38B]	k  = 128 / 192 / 256	Yes
10	Random number generation	Hybrid-Physical PTG.3 based on	[AIS31]	N/A	Yes
		CTR_DRBG with AES-128/192/256	[NIST SP800-90A] [FIPS197] (see [AGD_CL_RNG])		
		Hybrid-Physical PTG.3 based on	[AIS31]	N/A	Yes
		CTR_DRBG with TDES	[NIST SP800-90A] [NIST SP800-67] (see [AGD_CL_RNG])		
		Hybrid-Deterministic DRG.4 based on	[AIS31]	N/A	Yes
		CTR_DRBG with AES-128/192/256	[NIST SP800-90A] [FIPS197] (see [AGD_CL_RNG])		
		Hybrid-Deterministic DRG.4 based on	[AIS31]	N/A	Yes
		CTR_DRBG with TDES	[NIST SP800-90A] [NIST SP800-67] (see [AGD_CL_RNG])		
Flasi	Flash Loader (optional, depends on crypto library)				
11	Confidentiality	AES in CBC mode with constant IV	[FIPS197] [NIST SP800-38A]	k  = 128	Yes
12	Authenticity	AES in CMAC mode for MAC verification	[FIPS197] [NIST SP800-38B]	k  = 128	Yes

No.	Purpose	Cryptographic Mechanism	Standard of Implementation	Key Size in Bits	Security Level above 100 Bits
13	Key derivation	KBKDF based on AES in CMAC mode	[NIST SP800-108] [FIPS197] [NIST SP800-38B]	k  = 128	Yes
			[ADV_ATE, 6.12.3.4.1.2.6])		
14	Authentication	Mutual authentication protocol based on MAC generation and verification with AES in CMAC mode	[ADV_ATE, 6.12.3.4.1.2.8] [FIPS197] [NIST SP800-38B]	k  = 128	Yes

Table 3: TOE cryptographic functionality

[AIS31]	Anwendungshinweise und Interpretationen zum Schema (AIS) – AIS 31, Funktionalitätsklassen und Evaluationsmethodologie für physikalische Zufallszahlengeneratoren, Version 3, 2013-05-15, Bundesamt für Sicherheit in der Informationstechnik.
[FIPS 197]	Federal Information Processing Standards Publication 197, Announcing the ADVANCED ENCRYPTION STANDARD (AES), 2001-11-26, National Institute of Standards and Technology (NIST).
[ISO_9797-1]	ISO 9797-1: Information technology – Security techniques - Message Authentication Codes (MACs) - Part 1: Mechanisms using a block cipher, 1999-12, ISO/IEC.
[NIST SP 800-38A]	NIST Special Publication 800-38A, Recommendation for BlockCipher Modes of Operation, National Institute of Standards and Technology (NIST), Technology Administration, U.S. Department of Commerce.
[NIST SP 800-38B]	NIST Special Publication 800-38B, Recommendation for BlockCipher Modes of Operation: The CMAC Mode for Authentication, May 2005, National Institute of Standards and Technology.
[NIST SP 800-67]	NIST Special Publication 800-67 –Revision 2, Recommendation for the Triple Data Encryption Algorithm (TDEA) Block Cipher – Revised January 2017, National Institute of Standards and Technology (NIST), Technology Administration, U.S. Department of Commerce
[NIST SP 800-90a]	NIST Special Publication 800-67 –Revision 2, Recommendation for the Triple Data Encryption Algorithm (TDEA) Block Cipher – Revised January 2017, National Institute of Standards and Technology (NIST), Technology Administration, U.S. Department of Commerce
[NIST SP800-108]	NIST SP 800-108, Recommendation for Key Derivation Using Pseudorandom Functions (Revised), October 2009, National Institute of Standards and Technology.
[ADV_ATE]	NXP Secure Smart Card Controller N7021 Classes ADV and ATE – Sys.P4, Version 1.7, 2020-04-09, NXP Semiconductors
[AGD_CL_RNG]	N7021 Crypto Library RNG Library, Product user manual, Version 1.3, 2017-03-27, NXP Semiconductors

## 10. Obligations and Notes for the Usage of the TOE

The documents as outlined in table 2 contain necessary information about the usage of the TOE and all security hints therein have to be considered. In addition all aspects of

Assumptions, Threats and OSPs as outlined in the Security Target not covered by the TOE itself need to be fulfilled by the operational environment of the TOE.

The customer or user of the product shall consider the results of the certification within his system risk management process. In order for the evolution of attack methods and techniques to be covered, he should define the period of time until a re-assessment of the TOE is required and thus requested from the sponsor of the certificate.

The limited validity for the usage of cryptographic algorithms as outlined in chapter 9 has to be considered by the user and his system risk management process, too.

Some security measures are partly implemented in this certified TOE, but require additional configuration or control or measures to be implemented by a product layer on top, e.g. the IC Dedicated Support Software and/or Embedded Software using the TOE. For this reason the TOE includes guidance documentation (see table 2) which contains obligations and guidelines for the developer of the product layer on top on how to securely use this certified TOE and which measures have to be implemented in order to fulfil the security requirements of the Security Target of the TOE. In the course of the evaluation of the composite product or system it must be examined if the required measures have been correctly and effectively implemented by the product layer on top. Additionally, the evaluation of the composite product or system must also consider the evaluation results as outlined in the document "ETR for composite evaluation" [10].

At the point in time when evaluation and certification results are reused there might be an update of the document "ETR for composite evaluation" available. Therefore, the certified products list on the BSI website has to be checked for latest information on reassessments, recertifications or maintenance result available for the product.

## 11. Security Target

For the purpose of publishing, the Security Target [9] of the Target of Evaluation (TOE) is provided within a separate document as Annex A of this report. It is a sanitised version of the complete Security Target [6] used for the evaluation performed. Sanitisation was performed according to the rules as outlined in the relevant CCRA policy (see AIS 35 [4]).

## 12. Regulation specific aspects (elDAS, QES)

None

#### 13. Definitions

#### 13.1. Acronyms

AIS Application Notes and Interpretations of the Scheme

BSI Bundesamt für Sicherheit in der Informationstechnik

**BSIG** BSI-Gesetz / Act on the Federal Office for Information Security

CCRA Common Criteria Recognition ArrangementCC Common Criteria for IT Security Evaluation

**CEM** Common Methodology for Information Technology Security Evaluation

**cPP** Collaborative Protection Profile

EAL Evaluation Assurance Level
ETR Evaluation Technical Report

IT Information Technology

ITSEF Information Technology Security Evaluation Facility

**PP** Protection Profile

SAR Security Assurance Requirement

**SFP** Security Function Policy

**SFR** Security Functional Requirement

**ST** Security Target

**TOE** Target of Evaluation

**TSF** TOE Security Functionality

#### 13.2. Glossary

Augmentation - The addition of one or more requirement(s) to a package.

**Collaborative Protection Profile** - A Protection Profile collaboratively developed by an International Technical Community endorsed by the Management Committee.

**Extension** - The addition to an ST or PP of functional requirements not contained in CC part 2 and/or assurance requirements not contained in CC part 3.

**Formal** - Expressed in a restricted syntax language with defined semantics based on well-established mathematical concepts.

**Informal** - Expressed in natural language.

**Object** - A passive entity in the TOE, that contains or receives information, and upon which subjects perform operations.

Package - named set of either security functional or security assurance requirements

**Protection Profile** - A formal document defined in CC, expressing an implementation independent set of security requirements for a category of IT Products that meet specific consumer needs.

**Security Target** - An implementation-dependent statement of security needs for a specific identified TOE.

**Semiformal** - Expressed in a restricted syntax language with defined semantics.

**Subject** - An active entity in the TOE that performs operations on objects.

**Target of Evaluation** - An IT Product and its associated administrator and user guidance documentation that is the subject of an Evaluation.

**TOE Security Functionality** - Combined functionality of all hardware, software, and firmware of a TOE that must be relied upon for the correct enforcement of the SFRs.

## 14. Bibliography

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- AIS 20, Version 3, Funktionalitätsklassen und Evaluationsmethodologie für deterministische Zufallszahlengeneratoren
- AIS 25, Version 9, Anwendung der CC auf Integrierte Schaltungen including JIL Document and CC Supporting Document, 15.03.2017
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## C. Excerpts from the Criteria

For the meaning of the assurance components and levels the following references to the Common Criteria can be followed:

- On conformance claim definitions and descriptions refer to CC part 1 chapter 10.5
- On the concept of assurance classes, families and components refer to CC Part 3 chapter 7.1
- On the concept and definition of pre-defined assurance packages (EAL) refer to CC Part 3 chapters 7.2 and 8
- On the assurance class ASE for Security Target evaluation refer to CC Part 3 chapter 12
- On the detailed definitions of the assurance components for the TOE evaluation refer to CC Part 3 chapters 13 to 17
- The table in CC part 3 , Annex E summarizes the relationship between the evaluation assurance levels (EAL) and the assurance classes, families and components.

The CC are published at <a href="https://www.commoncriteriaportal.org/cc/">https://www.commoncriteriaportal.org/cc/</a>

#### D. Annexes

## List of annexes of this certification report

Annex A: Security Target provided within a separate document.

Annex B: Evaluation results regarding development

and production environment

## Annex B of Certification Report BSI-DSZ-CC-0977-V3-2021

# **Evaluation results regarding development and production environment**



The IT product NXP Secure Smart Card Controller N7021 VA including IC Dedicated Software (Target of Evaluation, TOE) has been evaluated at an approved evaluation facility using the Common Methodology for IT Security Evaluation (CEM), Version 3.1 extended by Scheme Interpretations by advice of the Certification Body for components beyond EAL 5 and CC Supporting Documents for conformance to the Common Criteria for IT Security Evaluation (CC), Version 3.1.

As a result of the TOE certification, dated 24 February 2021, the following results regarding the development and production environment apply. The Common Criteria assurance requirements ALC – Life cycle support (i.e. ALC\_CMC.5, ALC\_CMS.5, ALC\_DEL.1, ALC\_DVS.2, ALC\_FLR.1, ALC\_LCD.1, ALC\_TAT.3)

are fulfilled for the development and production sites of the TOE listed below:

Name of site / Company name	Adress	Function
Development Sites		
NXP Hamburg	NXP Semiconductors Germany GmbH Troplowitzstr. 20 22529 Hamburg Germany	Project management, central design database, HW/FW/SW development and verification, security architecture and evaluation, flaw remediation, trust provisioning, and customer support.
NXP Gratkorn	NXP Semiconductors Austria GmbH Mikronweg 1 8101 Gratkorn Austria	Project management, HW/FW/SW development and verification, security architecture and evaluation, trust provisioning, and document control system (DocStore).
NXP Eindhoven Development	NXP Semiconductors Building 46, High Tech Campus HTC-46.3-west 5656 AE Eindhoven The Netherlands	HW/FW/SW development, security architecture.
NXP Glasgow 2	NXP Glasgow EK Pegasus House, Scottish Enterprise Technology Park, Bramah Ave East Kilbride, Glasgow G75 0RD	Hardware development, security architecture and reviews.

	Scotland, UK	
NXP Leuven	NXP Semiconductors Interleuvenlaan 80 B-3001 Leuven Belgium	Hardware development, security reviews.
NXP Munich North	NXP Semiconductors Germany GmbH Schatzbogen 7 81829 Munich Germany	SW development.
NXP Nijmegen	NXP Semiconductors Nijmegen B.V. Gerstweg 2 6534AE Nijmegen The Netherlands	Verification of design data and mask data, sample preparation.
GlobalLogic Wroclaw	GlobalLogic REC sp. z o.o. Strzegomska 56B Street 53-611 Wroclaw Poland	SW development and verification.
Sii Gdansk 2	SII Olivia Prime Building, 10th floor, Grunwaldzka 472E 80-309 Gdansk Poland	SW development and verification.
NXP Eindhoven IT	NXP Semiconductors Netherlands B.V. Building 60, High Tech Campus HTC60, Secure Room (rooms 131, 133) 5656 AG Eindhoven The Netherlands	IT engineering and generic support.
NXP Bangalore	NXP India Private Limited  Manyata Technology Park, Nagawara Village, Kasaba Hobli Bangalore 560 045 India	Data center.

Colt Datacenter Hamburg	Colt Datacenter Hamburg Obenhauptstrasse 22335 Hamburg Germany	Data center.	
Akquniet Datacenter Hamburg	Akquinet Datacenter Hamburg Ulzburger Strasse 201 22850 Norderstedt Germany	Data center.	
Digital Reality Phoenix	Digital Realty Data Center 120 E Van Buren St, Phoenix AZ 85004 U.S.A.	Data center.	
Equinix Singapore	EQUINIX 20 Ayer Rajah Crescent, IBX SG1, Level 5 Unit 5, Ayer Rajah Industrial Park 139964 Singapore	Data center.	
NXP Bucharest	NXP Semiconductors Romania Campus 6, Bulevardul Iuliu Maniu 6L, 061103 Bucureşti Romania	IT engineering and support.	
NXP Guadalajara	NXP Guadalajara Periferico Sur #8110 Col. El Mante JALISCO, 45609 Tlaquepaque Mexico	IT engineering and support.	
Production Sites			
TSMC Hsinchu	Taiwan Semiconductor Manufacturing Company Limited Fab 2/5, Fab 8, Fab 14A	Mask data preparation, Mask and wafer production.	
Chipbond Hsinchu	Chipbond Technology Corporation No. 3, Li-Hsin Rd. V Science Based Industrial Park Hsin-Chu City Taiwan, R.O.C.	Bumping.	

NXP ATBK	NXP Semiconductors Thailand (ATBK) 303 Moo 3 Chaengwattana Rd., Laksi	Test centre, wafer treatment, module assembly, (pre-) personalization, delivery, and test program engineering (TPE).
	Bangkok 10210	
	Thailand	
NXP ATKH	NXP Semiconductors Taiwan Ltd (ATKH)	Test centre, wafer treatment, module assembly, (pre-) personalization, and delivery.
	#10, Chin 5th Road, N.E.P.Z	
	Kaohsiung 81170	
	Taiwan, R.O.C.	
NXP Hamburg	See NXP Hamburg.	Test Centre, personalization, and delivery.

Table 4: Relevant development/production sites

For the sites listed above, the requirements have been specifically applied in accordance with the Security Target [6]. The evaluators verified, that the threats, security objectives and requirements for the TOE life cycle phases up to delivery (as stated in the Security Target [6] and [9]) are fulfilled by the procedures of these sites.

Note: End of report